

ICCSA 2019

The 3rd International Conference on
Circuits, Systems and Devices
Chengdu, China | Aug. 23–25, 2019



ICCSA 2019


<http://iccsa.org/>

The age of 5G communication is approaching. You are invited to participate in The 3rd International Conference on Circuits, Systems and Devices (ICCSA 2019) in Chengdu, China, August 23-25, 2019. ICCSA is supported by Sichuan Institute of Electronics, UESTC, Southeast University, China and University of Detroit Mercy, USA, it will provide a premier interdisciplinary platform for researchers, practitioners and educators to present and discuss the most recent innovations, trends, and concerns as well as practical challenges encountered and solutions adopted in the fields of Circuits, Systems and Devices.

Important Dates

Submission Deadline:**March 15th, 2019****Notification Date:**

April 5th, 2019

Registration Deadline:

April 25th, 2019

Topics

Circuits, devices and systems
Smart grid and circuit
Signal and multimedia processing
Computers, software and applications
Ocean engineering and marine technology
Biomedical electronics and bioinformatics
Communication engineering
Electronics and electrical engineering
Computer science applications
Nano electro mechanical System
Photonics and optoelectronics
Networking, communication and multimedia
Information engineering
Software specification and software assurance
Analysis of power quality and system stability
Assembly and packaging
Analog circuits and digital circuits
Antenna and propagation
Electric energy processing
Electromagnetic and photonics
Electro-optical phenomena of semiconductors
Power electronics and energy systems
Signal processing
Simulation of propagation
Battery management system
Circuits and electronics
Solar power generation
Wind power generation

Proceedings

Accepted and registered papers will be published into conference proceedings and indexed by **EI Compendex**, **Scopus** and etc.

Committee

Advisory Chair

Xiaoqing Wen, Kyushu Institute of Technology, Japan, IEEE Fellow

Conference Chairs

Zhi-Gong Wang, Southeast University, China

Qiang Li, University of Electronic Science and Technology of China, China

Program Chairs

Li Wenyuan, Southeast University, China

Meng Zhang, Southeast University, China

Submission

<https://easychair.org/conferences/?conf=iccsa2019>

Contact

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第三届电路、系统与器件国际会议

中国·成都 | 2019年8月23日-25日

近年来的发展，多速率数字信号处理技术已经在众多领域中得到广泛运用，从无线和卫星通信系统，到语言和图像压缩，还包括高性能音频和视频、统计和自适应信号处理以及多媒体。5G时代正在迈向人们的生活，在此背景下，2019年第三届电路、系统与器件国际会议定于2019年8月23-25日在中国成都召开，会议得到四川省电子学会，电子科技大学、美国底特律大学与中国东南大学的大力支持，旨在为全世界科研学者、从业人员以及教育工作者提供一个最好的跨学科平台，探讨最近创新发明、最新发展趋势和近期共同关注，以及在电路设备与系统领域里面面临的现实挑战与解决方法。我们诚挚地邀请您参与 ICCSD 2019!

重要日期

投稿截止日:

2019年3月15日

录用通知日:

2019年4月5日

注册截止日:

2019年4月25日

征稿主题

Circuits, devices and systems
Smart grid and circuit
Signal and multimedia processing
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Battery management system
Circuits and electronics
Solar power generation
Wind power generation

论文集

大会接收并注册的全文将被收录到会议论文集，由 **El Compendex**、**Scopus** 等机构检索。

组委会

咨询委员会主席

Xiaoqing Wen, Kyushu Institute of Technology, Japan, IEEE Fellow

大会主席

Zhi-Gong Wang, Southeast University, China

Qiang Li, University of Electronic Science and Technology of China, China

程序委员会主席

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投稿系统

<https://easychair.org/conferences/?conf=iccds2019>

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